1. Package summary

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Min</th>
<th>Typ</th>
<th>Nom</th>
<th>Max</th>
<th>Unit</th>
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</thead>
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<tr>
<td>D</td>
<td>package length</td>
<td>0.72</td>
<td>-</td>
<td>0.77</td>
<td>0.82</td>
<td>mm</td>
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<tr>
<td>E</td>
<td>package width</td>
<td>1.12</td>
<td>-</td>
<td>1.17</td>
<td>1.22</td>
<td>mm</td>
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<tr>
<td>A</td>
<td>seated height</td>
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<td>-</td>
<td>0.57</td>
<td>0.6</td>
<td>mm</td>
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<tr>
<td>e</td>
<td>nominal pitch</td>
<td>-</td>
<td>-</td>
<td>0.4</td>
<td>-</td>
<td>mm</td>
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<tr>
<td>n_2</td>
<td>actual quantity of termination</td>
<td>-</td>
<td>-</td>
<td>5</td>
<td>-</td>
<td></td>
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</tbody>
</table>
2. Package outline

Fig. 1. Package outline WLCSP5 (WLCSP5_2-1-2)
3. Legal information

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WLCSP5_2-1-2  

wafer level chip-size package; 5 bumps (2-1-2); 0.4 mm pitch; 0.77 x 1.17 x 0.57 mm body

4. Contents

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